1.8 V / 2.5 V / 3.3 V Differential 2:1 Clock / Data Multiplexer / Translator with CML Outputs

Multi–Level Inputs w/ Internal Termination

Description

The NB7V58M is a high performance differential 2–to–1 Clock or Data multiplexer. The differential inputs incorporate internal 50 Ω termination resistors that are accessed through the VT pin. This feature allows the NB7V58M to accept various logic level standards, such as LVPECL, CML or LVDS.

The NB7V58M produces minimal Clock or Data jitter operating up to 7 GHz or 10.7 Gb/s, respectively. As such, the NB7V58M is ideal for SONET, GigE, Fiber Channel, Backplane and other Clock/Data distribution applications.

The 16 mA differential CML outputs provide matching internal 50 Ω terminations and 400 mV output swings when externally terminated with a 50 Ω resistor to V_{CC}.

The NB7V58M is offered in a low profile 3 mm x 3 mm 16-pin QFN package and is a member of the GigaComm^M family of high performance Clock / Data products. For applications that require equalization, the pin-compatible NB7VQ58M is also available. Application notes, models, and support documentation are available at www.onsemi.com.

Features

- Maximum Input Data Rate > 10.7 Gb/s
- Data Dependent Jitter < 10 ps
- Maximum Input Clock Frequency > 7 GHz
- Random Clock Jitter < 0.8 ps RMS
- 180 ps Typical Propagation Delay
- 35 ps Typical Rise and Fall Times
- Differential CML Outputs, 400 mV Peak-to-Peak, Typical
- Operating Range: $V_{CC} = 1.71$ V to 3.6 V with GND = 0 V
- Internal 50 Ω Input Termination Resistors
- QFN-16 Package, 3 mm x 3 mm
- -40°C to +85°C Ambient Operating Temperature
- This is a Pb–Free Device



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= Pb-Free Package

(Note: Microdot may be in either location)





ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.



Figure 1. Pin Configuration (Top View)

Table 1. SELect FUNCTION TRUTH TABLE

SEL	Q	Q
L	INO	ĪNO
н	IN1	ĪN1

Table 2. PIN DESCRIPTION

Multi-Level Inputs LVPECL, LVDS, CML



Figure 2. Detailed Block Diagram

Pin	Name	I/O	Description
1	IN0	LVPECL, CML, LVDS Input	Noninverted Differential Input (Note 1)
2	ĪNŌ	LVPECL, CML, LVDS Input	Inverted Differential Input (Note 1)
3	IN1	LVPECL, CML, LVDS Input	Noninverted Differential Input (Note 1)
4	ĪN1	LVPECL, CML, LVDS Input	Inverted Differential Input (Note 1)
5	VT1	-	Internal 50 Ω Termination Pin for IN1/IN1
6	SEL	LVTTL/LVCMOS Input	SEL Input. Low for IN0 inputs, high for IN1 inputs. (Note 1) Pin will default HIGH when left open (has internal pull-up resistor)
7	NC		No Connect
8	VCC	-	Positive Supply Voltage (Note 2)
9	Q	CML Output	Inverted Differential Output
10	GND	-	Negative Supply Voltage
11	GND	-	Negative Supply Voltage
12	Q	CML Output	Noninverted Differential Output
13	VCC	-	Positive Supply Voltage (Note 2)
14	GND	-	Negative Supply Voltage
15	GND	-	Negative Supply Voltage
16	VT0	-	Internal 50 Ω Termination Pin for IN0/IN0
-	EP	-	The Exposed Pad (EP) on the QFN-16 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat-sinking conduit. The pad is electrically connected to the die, and must be electrically and thermally connected to GND on the PC board.

1. In the differential configuration when the input termination pins (VT0, VT1) are connected to a common termination voltage or left open, and if no signal is applied on IN0/IN0, IN1/IN1 inputs, then the device will be susceptible to self–oscillation. Q/Q outputs have internal 50 Ω source termination resistors.

2. All VCC and GND pins must be externally connected to a power supply for proper operation.

Table 3. ATTRIBUTES

Characteristic	Value			
ESD Protection	Human Body Model Machine Model	> 2 kV > 200 V		
R _{PU} – SEL Input Pull–up Resistor		25 kΩ		
Moisture Sensitivity (Note 3)	QFN-16	Level 1		
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in		
Transistor Count	312			
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test				

3. For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	Positive Power Supply	GND = 0 V		4.0	V
V _{IN}	Positive Input Voltage	GND = 0 V		–0.5 to V _{CC} +0.5	V
V _{INPP}	Differential Input Voltage INn - INn			1.89	V
I _{OUT}	Output Current	Continuous Surge		34 40	mA
I _{IN}	Input Current Through R_T (50 Ω Resistor)			±40	mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient) (Note 4)	0 LFPM 500 LFPM	QFN-16 QFN-16	42 35	°C/W
θ_{JC}	Thermal Resistance (Junction-to-Case) (Note 4)		QFN-16	4	°C/W
T _{sol}	Wave Solder Pb-Free			265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.
JEDEC standard multilayer board – 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

Symbol	Characteristic		Min	Тур	Max	Unit
POWER	SUPPLY CURRENT					
I _{CC}	Power Supply Current (Inputs and Outputs Open)			100	150	mA
CML OU	TPUTS (Note 6)					
V _{OH}	Vc	C = 3.3 V C = 2.5 V C = 1.8 V	V _{CC} - 30 3270 2470 1770	V _{CC} – 5 3295 2495 1795	V _{CC} 3300 2500 1800	mV
V _{OL}	Vc	C = 3.3 V C = 2.5 V C = 1.8 V	V _{CC} - 500 2800 2000 1300	V _{CC} - 400 2900 2100 1400	V _{CC} - 300 3000 2200 1500	mV
DIFFERE	INTIAL INPUTS DRIVEN SINGLE-ENDED (Note 7) (Figures 6	& 8)				
V _{th}	Input Threshold Reference Voltage Range (Note 8)		1050		V _{CC} – 100	mV
V _{IH}	Single-ended Input HIGH Voltage		V _{th} + 100		V _{CC}	mV
V _{IL}	Single-ended Input LOW Voltage		GND		V _{th} – 100	mV
V _{ISE}	Single-ended Input Voltage (V _{IH} - V _{IL})		200		1200	mV
DIFFERE	ENTIAL INO/ \overline{INO} , IN1/ $\overline{IN1}$, INPUTS DRIVEN DIFFERENTIALLY	(Figures 6 & 9) (Note 9)			
V _{IHD}	Differential Input HIGH Voltage		1100		V _{CC}	mV
V _{ILD}	Differential Input LOW Voltage		GND		V _{CC} - 100	mV
V _{ID}	Differential Input Voltage (V _{IHD} – V _{ILD})		100		1200	mV
V _{CMR}	Input Common Mode Range (Differential Configuration, Note ure 10)	10) (Fig-	1050		V _{CC} – 50	mV
I _{IH}	Input HIGH Current (VTn Open)		-150		150	μA
IIL	Input LOW Current (VTn Open)		-150		150	μA
CONTRO	DL INPUT (SEL)					
V _{IH}	Input HIGH Voltage		V _{CC} x 0.65		V _{CC}	mV
V _{IL}	Input LOW Voltage		GND		V _{CC} x 0.35	mV
I _{IH}	Input HIGH Current		-150		+150	μA
IIL	Input LOW Current		-200		+200	μA
TERMINA	ATION RESISTORS					
R _{TIN}	Internal Input Termination Resistor		45	50	55	Ω
R _{TOUT}	Internal Output Termination Resistor		45	50	55	Ω

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. Input and output parameters vary 1:1 with V_{CC} .

6. CML outputs loaded with 50 Ω to V_{CC} for proper operation. 7. Vth, V_{IH}, V_{IL} and V_{ISE} parameters must be complied with simultaneously.

8. Vth is applied to the complementary input when operating in single-ended mode.

9. V_{IHD} , V_{ILD} , V_{ID} and V_{CMR} parameters must be complied with simultaneously. 10. V_{CMR} min varies 1:1 with GND, V_{CMR} max varies 1:1 with V_{CC} . The V_{CMR} range is referenced to the most positive side of the differential input signal.

Symbol	Characteristic		Min	Тур	Max	Unit
f _{MAX}	Maximum Input Clock Frequency	Voutpp ≥ 200 mV	7	8		GHz
f _{DATAMAX}	Maximum Operating Data Rate (PRBS23)		10.7	12		Gbps
fSEL	Maximum Toggle Frequency, SEL		25	50		MHz
V _{OUTPP}	Output Voltage Amplitude (@ V _{INPPmin}) (Note 12) (Figures 8 & 10)	$f_{in} \le 7 \text{ GHz}$	200	400		mV
t _{PLH} , t _{PHL}	Propagation Delay to Differential Outputs, @ 1 GHz, measured at differential cross-point	INn/ INn to Q, <u>Q</u> SEL to Q, <u>Q</u>	120 5	180 13	240 22	ps ns
t _{PLH} TC	Propagation Delay Temperature Coefficient			50		∆fs/°C
t _{skew}	vice – Device skew (tpdmax – tpdmin)				50	ps
t _{DC}	Output Clock Duty Cycle (Reference Duty Cycle = 50%)	$\begin{array}{l} f_{in} \leq 5.0 \; \text{GHz} \\ f_{in} \leq 7.0 \; \text{GHz} \end{array}$	45 40	50 50	55 60	%
t _{JITTER}	RJ – Output Random Jitter (Note 13) DJ – Residual Output Deterministic Jitter (Note 14)	$\begin{array}{l} f_{in} \leq 7.0 \; \text{GHz} \\ f_{in} \leq 10.7 \; \text{Gbps} \end{array}$		0.2	0.8 10	ps RMS ps pk–pk
$\Phi_{\sf N}$	Phase Noise, f _c = 1 GHz	10 kHz 100 kHz 1 MHz 10 MHz 20 MHz 40 MHz		-135 -136 -150 -151 -151 -151		dBc
t∫ _{ΦN}	Integrated Phase Jitter (Figure 4) f _c = 1 GHz, 12 kHz – 20 MHz Offset (RMS)			35		fs
	Crosstalk Induced Jitter (Adjacent Channel) (Note 15)				0.7	ps RMS
V _{INPP}	Input Voltage Swing (Differential Configuration) (Figure 10) (Note 16)				1200	mV
t _r , t _f	Output Rise/Fall Times @ 1 GHz (20% – 80%)	Q, <u>Q</u>	15	35	50	ps

Table 6. AC CHARACTERISTICS (V_{CC} = 1.71 V to 3.6 V; GND = 0 V; T_A = -40°C to 85°C) (Note 11	Table 6.	AC CHARACTERISTICS	$(V_{CC} = 1.71 \text{ V to } 3.6 \text{ V}; \text{ GND} = 0 \text{ V}; \text{ T}_{A} = -40^{\circ}\text{C to } 85^{\circ}\text{C})$	(Note 11)
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NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

11. Measured using a V_{INPP}min source, 50% duty cycle clock source. All output loading with external 50 Ω to V_{CC}. Input edge rates 40 ps (20% – 80%).

12. Output voltage swing is a single-ended measurement operating in differential mode.

13. Additive RMS jitter with 50% duty cycle clock signal.

14. Additive Peak-to-Peak data dependent jitter with input NRZ data at PRBS23 at 3 Gbps.

15. Crosstalk is measured at the output while applying two similar clock frequencies that are asynchronous with respect to each other at the inputs.

16. Input voltage swing is a single-ended measurement operating in differential mode.





igure 3. Output Voltage Amplitude (V_{OUTPP}) vs. Input Frequency (f_{in}) at Ambient Temperature (Typical)













Figure 8. V_{th} Diagram



















Figure 12. LVPECL Interface



Figure 14. Standard 50 Ω Load CML Interface



Figure 13. LVDS Interface



Figure 15. Capacitor-Coupled Differential Interface (V_T Connected to External V_{REFAC}) *V_{REFAC} Bypassed to Ground with 0.01 µF Capacitor



Figure 16. Typical CML Output Structure and Termination

ORDERING INFORMATION

Device	Package	Shipping [†]
NB7V58MMNG	QFN-16 (Pb-Free)	123 Units / Rail
NB7V58MMNHTBG	QFN-16 (Pb-Free)	100 / Tape & Reel
NB7V58MMNTXG	QFN-16 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS





- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- ASME T14.3M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.

COPLANABLY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS. Lmax CONDITION CAN NOT VIOLATE 0.2 MM MINIMUM SPACING BETWEEN LEAD TIP AND FLAG



SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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